



Call for papers



MIDEM 2026

61st INTERNATIONAL CONFERENCE ON MICROELECTRONICS, DEVICES AND MATERIALS WITH THE WORKSHOP ON INTEGRATED PHOTONICS

September 28th – 30th, 2026

Faculty of Electrical Engineering, University of Ljubljana
Tržaška cesta 25, 1000 Ljubljana, Slovenia

Chairs:

Asst. Prof. Dr. Matija Pirc
Dr. Andraž Debevc

DEADLINES:

Abstract submission:
May 15, 2026

Acceptance notification:
June 30, 2026

Full paper submission:
September 1, 2026

Accepted papers will be
published in the
Conference Proceedings.

Further information and
updates:
<http://www.midem-drustvo.si/>

TOPICS OF INTEREST include but are not limited to:

- Integrated photonic circuits, devices and systems (WS),
- Chips and semiconductor technologies,
- Sensors and actuators,
- Electromechanical devices and micro/nanosystems,
- Electronics, electromagnetic compatibility,
- Nanoelectronics, quantum chips and devices,
- Optoelectronics and photonics,
- Photovoltaic materials, devices and systems,
- Electronic materials science, technology and applications,
- Thick and thin film technologies,
- Education in microelectronics, devices and materials,
- Student projects.

ORGANIZER:

MIDEM Society - Society for Microelectronics, Electronic Components and Materials, Slovenia

PARTNERS:

UL FE, JSI, IMAPS - Slovenia Chapter, IEEE - Slovenia Section, Slovenian Competence Center on Chips and Semiconductor Technologies – CC Chip.si (Workshop organizer)